

# VSTF065R700NA

**Datasheet** 





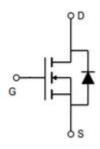
## $70m\Omega$ , 650V, N-Channel Power MOSFET

### VSTF065R700NA

## **General Description**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)_max</sub>	$I_D$
650V	70mΩ@10V	54A

## **Symbol**



Symbol of VSTF065R700NA

### **Features**

- Extremely low switching loss
- Excellent stability and uniformity
- RoHS and Halogen-Free Compliant

## **Application**

- PC power
- LED lighting
- Telecom power
- Server power
- Solar/UPS

## Package Type



TO-247

Package Type of VSTF065R700NA

## **Ordering Information**

Product Name	Package	Marking
VSTF065R700NA	TO-247	VSTF065R700NA



### VSTF065R700NA

## Absolute Maximum Ratings(T<sub>J</sub>= 25 °C, unless otherwise specified)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		$V_{ m DS}$	650	V
Gate-Source Voltage		$V_{GS}$	±30	V
Continuous Drain Current Note 1	$T_C=25$ °C	$I_D$	54	A
Pulsed Drain Current Note 2	$T_C=25$ °C	I <sub>D, pulse</sub>	162	A
Continuous Diode Forward Current Note 1	$T_C=25^{\circ}C$	$I_S$	54	A
Diode Pulsed Current Note 2	$T_C=25$ °C	I <sub>S, pulse</sub>	162	A
Max Power Dissipation Note 3	$T_C=25^{\circ}C$	$P_D$	500	W
Avalanche Current, Single Pulse Note 4		$I_{AS}$	11.4	A
Avalanche Energy, Single Pulse Note4		Eas	3899	mJ
MOSFET dv/dt ruggedness, V <sub>DS</sub> =0~480V		dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\sim480V$ , $I_{SD} \le I_D$		dv/dt	15	V/ns
Operation and storage temperature		T <sub>J</sub> ,T <sub>STG</sub>	-55 to 150	°C

### **Thermal Resistance**

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	-	0.25	-	°C/W
Thermal Resistance, Junction-to-Ambient Note5	$R_{ heta JA}$	-	62.5	-	C/W

#### **Notes:**

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4:  $V_{DD}$ =100V,  $V_{GS}$ =10V, L=60mH,  $R_G$ =25 $\Omega$ , starting  $T_A$ =25 °C.

Note5: When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.



## VSTF065R700NA

## **Electrical Characteristics** (T<sub>J</sub>= 25 °C, unless otherwise specified)

Parameter		Symbol	<b>Test Conditions</b>	Min	Тур	Max	Unit
Statistic Characteristics							
Drain-Source Breakdown Voltag	ge	$\mathrm{BV}_{\mathrm{DSS}}$	$V_{GS}$ =0V, $I_{D}$ =250uA	650	-	-	V
Drain-Source Leakage Current		$I_{DSS}$	$V_{DS}$ =650V, $V_{GS}$ =0V	-	-	1	uA
Gate-Source Leakage Current	Forward	$I_{GSSF}$	$V_{GS} = 30V, V_{DS} = 0V$	-	_	100	nA
Gate-Source Leakage Current	Reverse	$I_{GSSR}$	$V_{GS}$ =-30V, $V_{DS}$ =0V	-	_	-100	ПA
Gate Threshold Voltage		$V_{\text{GS(TH)}}$	$V_{DS}=V_{GS}$ , $I_{D}=250uA$	2.5	3.6	4.5	V
Drain-Source On-State Resistan	ce	$R_{\mathrm{DS}(\mathrm{ON})}$	$V_{GS}=10V, I_{D}=27A$	-	50	70	m $\Omega$
Gate Resistance		$R_{G}$	F=1MHz, Open Drain	-	4.24	-	Ω
<b>Dynamic Characteristics</b>							
Input Capacitance		$C_{iss}$	$V_{DS}=50V$		4752	-	pF
Output Capacitance		$C_{oss}$	V <sub>GS</sub> =0V	-	504	-	pF
Reverse Transfer Capacitance		$C_{rss}$	f=100kHz	-	12.2	-	pF
Turn-on Delay Time		$t_{d(on)}$	V <sub>DS</sub> =400V	-	80.15	-	
Rise Time		$t_{\rm r}$	I <sub>D</sub> =30A	-	29.97	-	ns
Turn-off Delay Time		$t_{\rm d(off)}$	$R_G=25\Omega$	-	297	-	ns
Fall Time		$t_{\mathrm{f}}$	$V_{GS}=10V$	-	18.49	-	
<b>Gate Charge Characteristics</b>							
Gate to Source Charge		$Q_{gs}$	V <sub>DS</sub> =400V	7-	24.2	-	
Gate to Drain Charge		$Q_{\mathrm{gd}}$	$I_D=30A$	-	38.5	-	nC
Gate Charge Total		$Q_{g}$	$V_{GS}=0$ to $10V$	-	90.2	-	
Gate Plateau Voltage		$V_{Plateau}$	V GS=0 to 10 V	-	5.38	-	V
<b>Reverse Diode Characteristics</b>							
Drain-Source Diode Forward Vo	oltage	$ m V_{SD}$	$V_{GS}=0V, I_S=1A$	-	0.68	1.4	V
Reverse Recovery Time		$t_{rr}$	V <sub>R</sub> =400V	-	507	-	ns
Reverse Recovery Charge		Qrr	$I_{\rm S}=30A$	-	10220	-	nC
Peak Reverse Recovery Current		I <sub>rrm</sub>	di/dt=100A/us	-	41.59	7-1	A



## **Electrical Characteristics Diagrams**

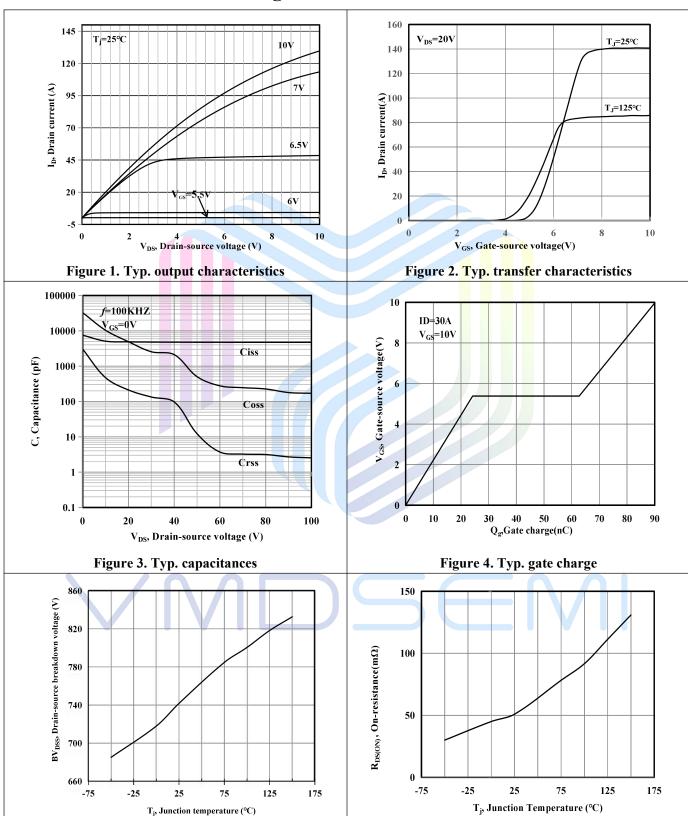


Figure 5. Drain-source breakdown voltage

Figure 6. Drain-source on-state resistance



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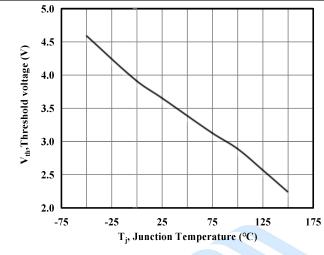


Figure 7. Threshold voltage

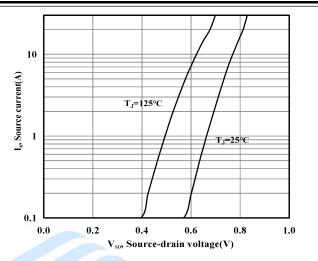


Figure 8. Forward characteristic of body diode

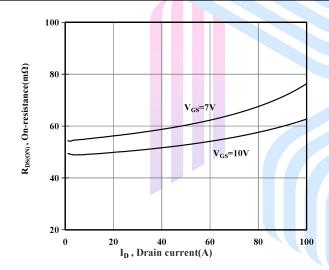


Figure 9. Drain-source on-state resistance

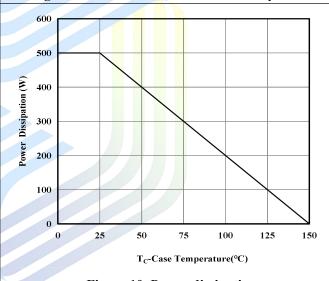
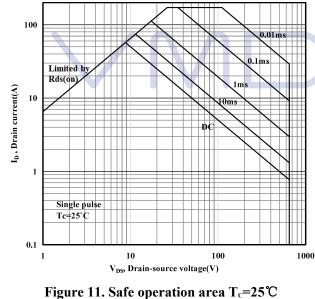


Figure 10. Power dissipation



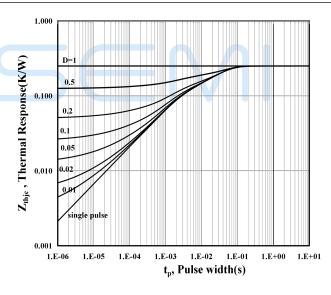


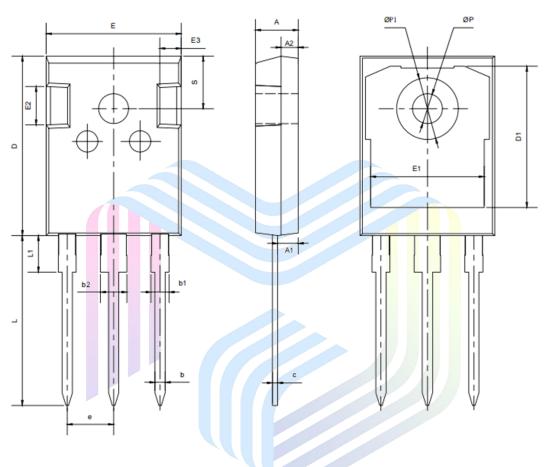
Figure 12. Max. transient thermal impedance



## $70m\Omega$ , 650V, N-Channel Power MOSFET

## **Mechanical Dimensions**

**TO-247 Package Information** 



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	MAX
Α	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.11	1.36
b1	1.91	2.21
b2	2.91	3.21
С	0.51	0.75
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.00	13.60
E2	4.80	5.60
E3	2.10	2.70
е	5.44	BSC
L	19.62	20.22
L1	-	4.30
φР	3.40	3.80
φP1	-	7.30
S	6.15	BSC

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